

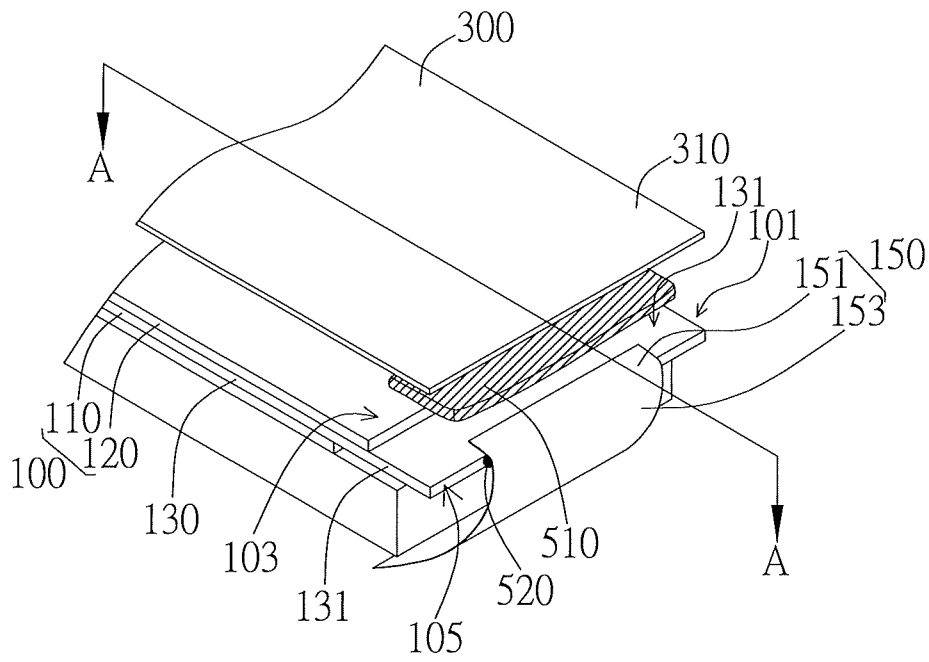


FIG. 1

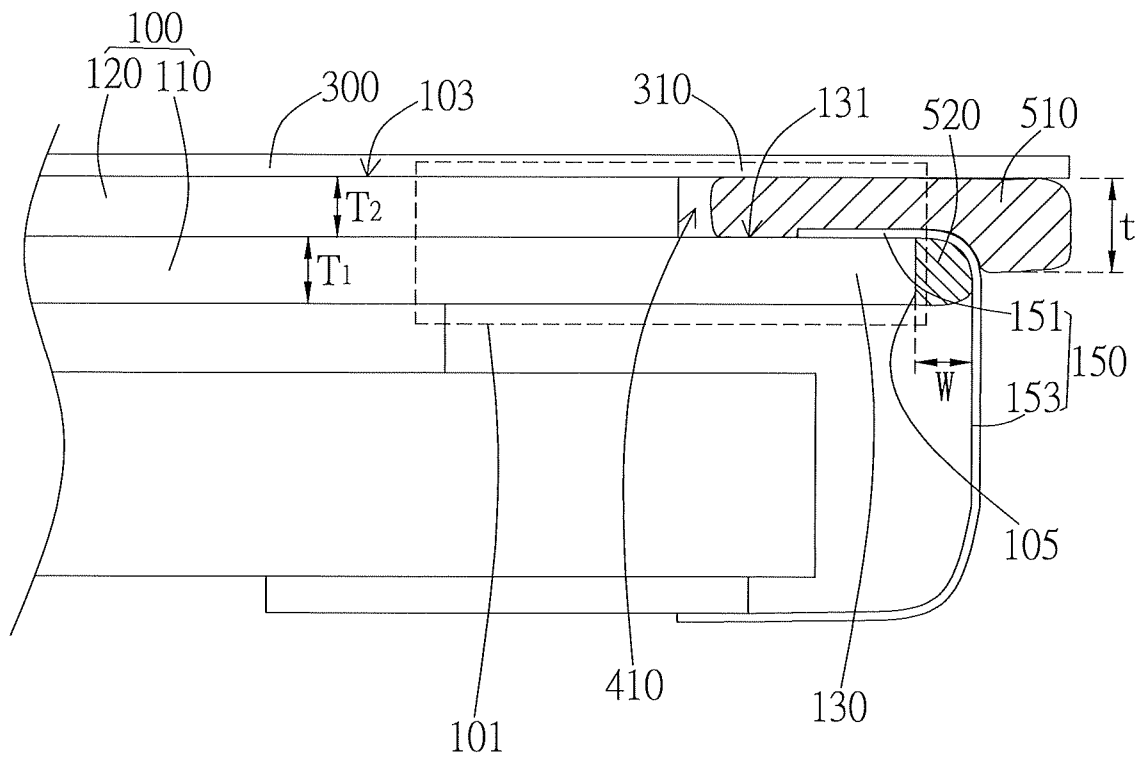


FIG. 2

Diagram illustrating a cross-sectional view of a device 100. The device includes a substrate 101, a layer 105, a layer 520, and a layer 150. A dimension D_1 is indicated across the width of the device.

FIG. 4

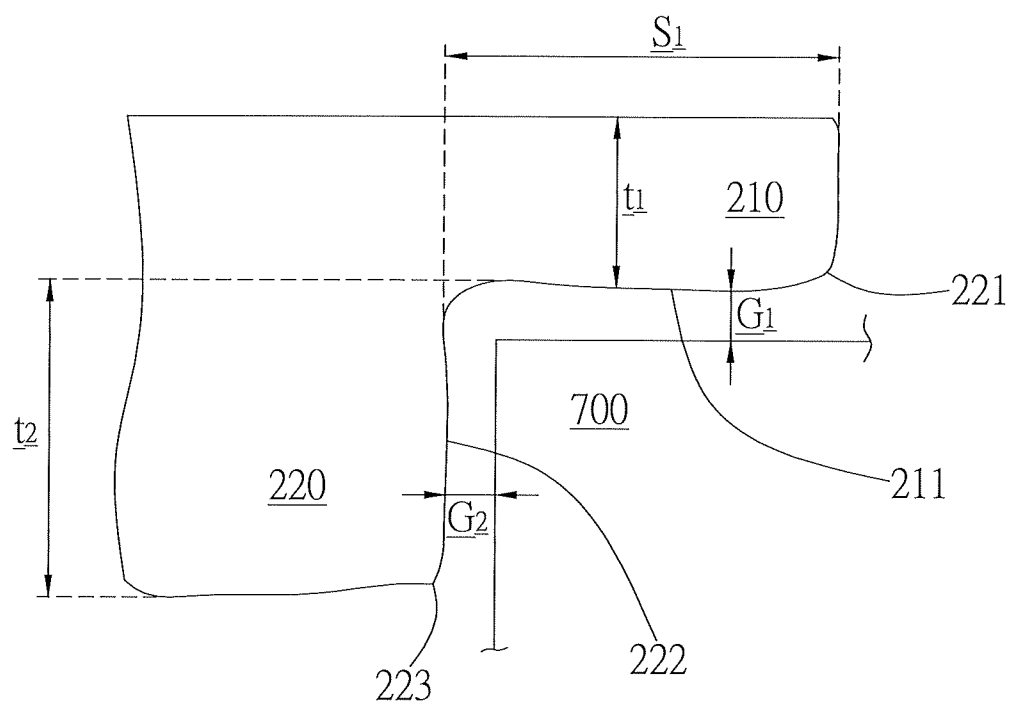


FIG. 6

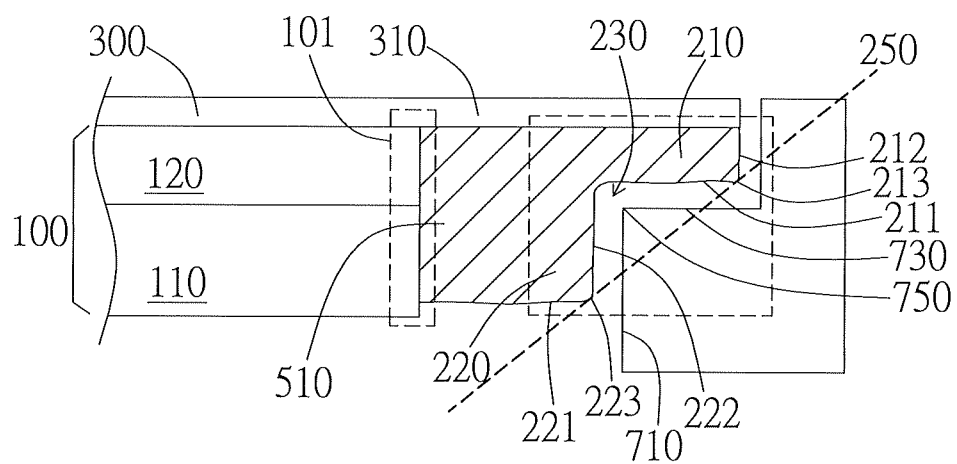


FIG. 7